

STGW20NB60KD

N-CHANNEL 20A - 600V TO-247 SHORT CIRCUIT PROOF PowerMESH™ IGBT

Table 1: General Features

TYPE	V _{CES}	V _{CE(sat)} (Max) @25°C	l c @100°C
STGW20NB60KD	600 V	< 2.8 V	25 A

- OFF LOSSES INCLUDE TAIL CURRENT
- **HIGH CURRENT CAPABILITY**
- HIGH INPUT IMPEDANCE (VOLTAGE DRIVEN)
- LOW ON-VOLTAGE DROP (V_{cesat})
- LOW ON-LOSSES
- LOW GATE CHARGE
- VERY HIGH FREQUENCY OPERATION
- SHORT CIRCUIT RATED
- LATCH CURRENT FREE OPERATION

DESCRIPTION

Using the latest high voltage technology based on a patented strip layout, STMicroelectronics has designed an advanced family of IGBTs, the PowerMESHTM IGBTs, with outstanding performances. The suffix "K" identifies a family optimized for high frequency motor control applications with short circuit withstand capability.

APPLICATIONS

- HIGH FREQUENCY MOTOR CONTROLS
- U.P.S
- WELDING EQUIPMENTS

Figure 1: Package



Figure 2: Internal Schematic Diagram

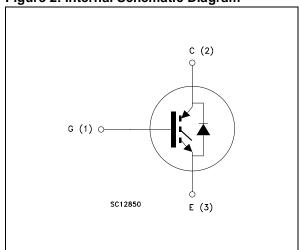


Table 2: Order Codes

SALES TYPE	MARKING	PACKAGE	PACKAGING	
STGW20NB60KD	GW20NB60KD	TO-247	TUBE	

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Table 3: Absolute Maximum ratings

Symbol	Parameter	Value	Unit	
V _{CES}	Collector-Emitter Voltage (V _{GS} = 0)	600	V	
V _{ECR}	Reverse Battery Protection	20	V	
V _{GE}	Gate-Emitter Voltage	± 20	V	
Ic	Collector Current (continuous) at 25°C (#)	50	А	
Ic	Collector Current (continuous) at 100°C (#)	25	А	
I _{CM} (1)	Collector Current (pulsed)	100	А	
T _{SC}	Short Circuit Withstand	10	μs	
Ртот	Total Dissipation at T _C = 25°C	170	W	
	Derating Factor	1.2	W/°C	
T _{stg}	Storage Temperature	- 55 to 150	°C	
Tj	Operating Junction Temperature	- 55 to 150		

⁽¹⁾Pulse width limited by max. junction temperature.

Table 4: Thermal Data

		Min.	Тур.	Max.	
Rthj-case	Thermal Resistance Junction-case			0.73	°C/W
Rthj-amb	b Thermal Resistance Junction-ambient			50	°C/W

Electrical Characteristics (T_{case} =25°C unless otherwise specified)

Table 5: Off

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _{BR(CES)}	Collectro-Emitter Breakdown Voltage	$I_C = 250 \mu A, V_{GE} = 0$	600			V
ICES	Collector-Emitter Leakage Current (V _{CE} = 0)	V _{GE} = Max Rating Tc=25°C Tc=125°C			10 100	μΑ μΑ
I _{GES}	Gate-Emitter Leakage Current (V _{CE} = 0)	V _{GE} = ± 20 V , V _{CE} = 0			± 100	nA

Table 6: On

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _{GE(th)}	Gate Threshold Voltage	V _{CE} = V _{GE} , I _C = 250 μA	5		7	V
V _{CE(SAT)}	Collector-Emitter Saturation Voltage	V _{GE} = 15 V, I _C = 20A, Tj= 25°C V _{GE} = 15 V, I _C = 20A, Tj= 125°C		2.3 1.9	2.8	V V

^(#) Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{JMAX} - T_{C}}{R_{THJ-C} \times V_{CESAT(MAX)}(T_{C}, I_{C})}$$

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ELECTRICAL CHARACTERISTICS (CONTINUED)

Table 7: Dynamic

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
9fs	Forward Transconductance	V _{CE} = 25 V, I _C = 20 A		8		S
C _{ies} C _{oes} C _{res}	Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{CE} = 25V, f = 1 \text{ MHz}, V_{GE} = 0$		1560 190 38		pF pF pF
Q _g Q _{ge} Q _{gc}	Total Gate Charge Gate-Emitter Charge Gate-Collector Charge	$V_{CE} = 480 \text{ V}, I_{C} = 20 \text{ A},$ $V_{GE} = 15 \text{ V},$ (see Figure 19)		85 14.4 51	115	nC nC nC
tscw	Short Circuit Withstand Time	$V_{ce} = 0.5 \text{ BV}_{ces}$, Tj = 125°C R _G = 10 Ω , V _{GE} = 15V	10			μs

Table 8: Switching On

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r	Turn-on Delay Time Current Rise Time	V_{CC} = 480 V, I_{C} = 20 A R_{G} = 10 Ω , V_{GE} = 15V, Tj= 25°C (see Figure 17)		39 35		ns ns
(di/dt) _{on} Eon (2)	Turn-on Current Slope Turn-on Switching Losses	$V_{CC} = 480 \text{ V, } I_{C} = 20 \text{ A}$ $R_{G} = 10\Omega, V_{GE} = 15\text{V, Tj} = 125^{\circ}\text{C}$ (see Figure 17)		453 675		A/μs μJ

²⁾ Eon is the turn-on losses when a typical diode is used in the test circuit in Figure 17. If the IGBT is offered in a package with a co-pack diode, the co-pack diode is used as external diode.

Table 9: Switching Off

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
$t_r(V_{off})$	Off Voltage Rise Time	$V_{CC} = 480 \text{ V}, I_{C} = 20 \text{ A},$		25		ns
t _c	Cross-over Time	$R_{GE} = 10 \Omega$, $V_{GE} = 15 V$ $T_{.I} = 25 °C$		160		ns
t _d (off)	Turn-off Delay Time	(see Figure 17)		105		ns
t _f	Current Fall Time			95		ns
E _{off} (3)	Turn-off Switching Loss			0.5		mJ
Ets	Total Switching Loss			0.9		mJ
$t_r(V_{Off})$	Off Voltage Rise Time	$V_{CC} = 480 \text{ V}, I_{C} = 20 \text{ A},$		46		ns
t _c	Cross-over Time	$R_{GE} = 10 \Omega$, $V_{GE} = 15 V$ Ti = 125 °C		175		ns
t _d (off)	Turn-off Delay Time	(see Figure 17)		130		ns
t _f	Current Fall Time			150		ns
E _{off} (3)	Turn-off Switching Loss			0.70		mJ
E _{ts}	Total Switching Loss			1.35		mJ

⁽³⁾Turn-off losses include also the tail of the collector current.



Table 10: Collector-Emitter Diode

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
I _f	Forward Current Forward Current pulsed				20 80	A A
V _f	Forward On-Voltage	I _f = 10 A I _f = 10 A, Tj = 125 °C		1.27 1	2.0	V V
t _{rr} Q _{rr} I _{rrm}	Reverse Recovery Time Reverse Recovery Charge Reverse Recovery Current	$I_f = 10 \text{ A ,V}_R = 27 \text{ V,}$ $T_j = 125^{\circ}\text{C, di/dt} = 100 \text{ A/}\mu\text{s}$ (see Figure 20)		80.5 181 4.5		ns nC A

Figure 3: Output Characteristics

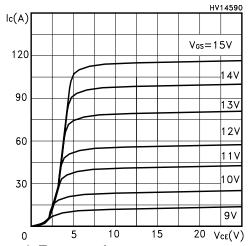


Figure 4: Transconductance

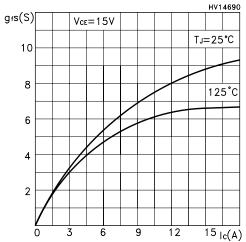


Figure 5: Collector-Emitter On Voltage vs Collector Current

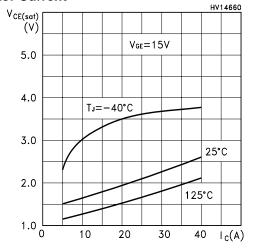


Figure 6: Transfer Characteristics

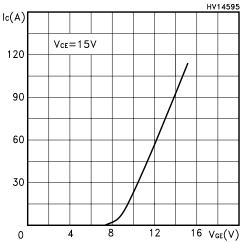


Figure 7: Collector-Emitter On Voltage vs Temperature

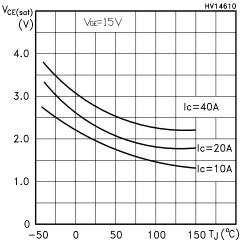


Figure 8: Normalized Gate Threshold vs Temperature

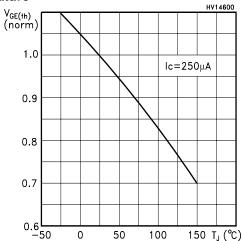


Figure 9: Normalized Breakdown Voltage vs Temperature

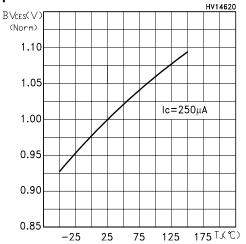


Figure 10: Capacitance Variations

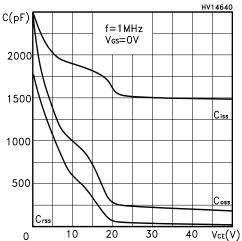


Figure 11: Turn-Off Energy Losses vs Temperature

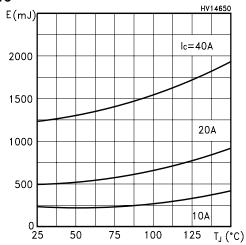


Figure 12: Gate Charge vs Gate-Emitter Voltage

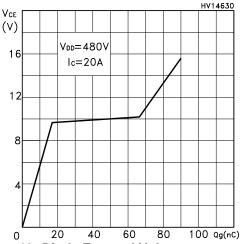


Figure 13: Diode Forward Voltage

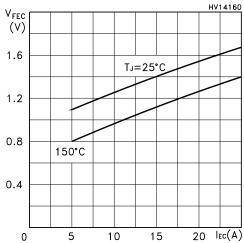
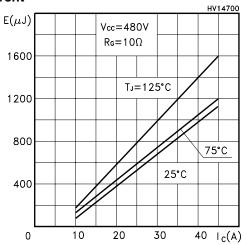


Figure 14: Total Switching Losses vs Collector Current



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Figure 15: Thermal Impedance

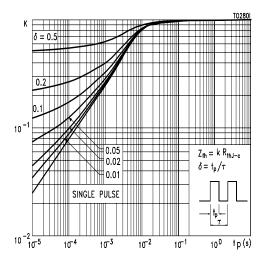


Figure 16: Turn-Off SOA

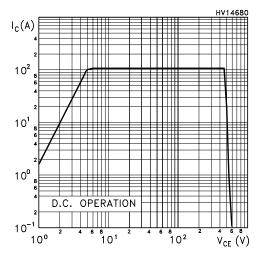


Figure 17: Test Circuit for Inductive Load Switching

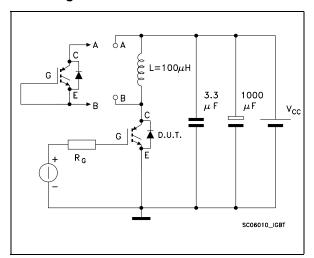


Figure 18: Switching Waveforms

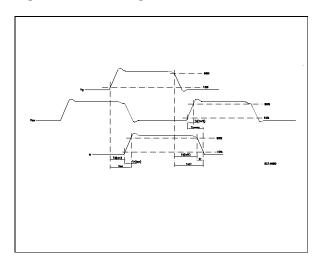


Figure 19: Gate Charge Test Circuit

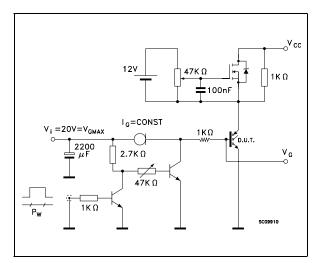
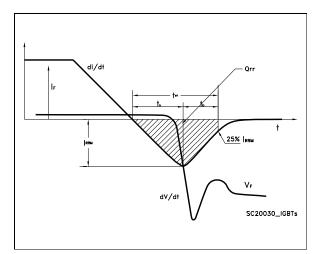


Figure 20: Diode Recovery Times Waveform



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TO-247 MECHANICAL DATA

DIM		mm.			inch	
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α	4.85		5.15	0.19		0.20
A1	2.20		2.60	0.086		0.102
b	1.0		1.40	0.039		0.055
b1	2.0		2.40	0.079		0.094
b2	3.0		3.40	0.118		0.134
С	0.40		0.80	0.015		0.03
D	19.85		20.15	0.781		0.793
E	15.45		15.75	0.608		0.620
е		5.45			0.214	
L	14.20		14.80	0.560		0.582
L1	3.70		4.30	0.14		0.17
L2		18.50			0.728	
øΡ	3.55		3.65	0.140		0.143
øR	4.50		5.50	0.177		0.216
S		5.50			0.216	

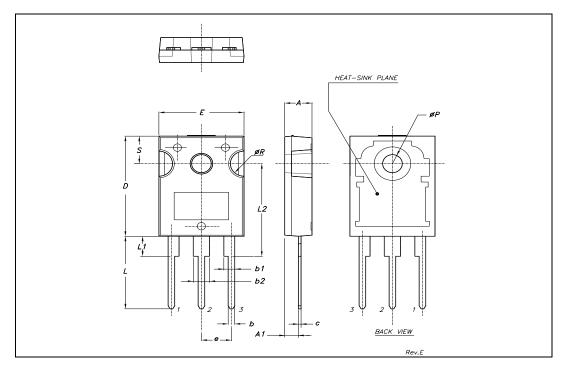


Table 11: Revision History

Date	Revision	Description of Changes
21-Mar-2005	2	New stylesheet. Some value changed on Table 3 and 4
05-Apr-2005	3	New updated values in table 3

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